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A centered hot plate method for measurement of thermal properties of thin insulating materials

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Abstract

This paper presents a method dedicated to thermal conductivity measurement of thin (a few millimeters thickness) insulating and super-insulating materials. The method is based on the measurement of the temperature at the center of a heating element inserted between two samples, with the unheated surface of the samples maintained constant. A 3D model of the heat transfer in the system has been established and simulated to determine the validity conditions of a 1D model to represent the center temperature. This 1D model was then used to realize a sensitivity analysis of the center temperature to the different parameters. The conclusion is that the thermal conductivity may be estimated with a good precision for all insulating materials from a simple steady state measurement and that the thermal capacity may also be estimated from transient recording of the temperature with a precision increasing with the value of the thermal capacity of the samples. It has then been shown that a device with two samples of different thickness improves the precision of the estimation of the thermal capacity. These conclusions are validated by an experimental study on polyethylene foam and PVC samples leading to an estimation of their thermal properties very close to the values measured by other classical methods (deviation < 5%).

Keywords: thermal conductivity, thermal capacity, hot plate, transient method, insulating material

(Some figures in this article are in colour only in the electronic version)

Nomenclature

- *a* thermal diffusivity ($m^2 s^{-1}$)
- *b* sample and heat element half-width (m)
- c specific heat $(J \text{ kg}^{-1} \text{ K}^{-1})$
- C_t total thermal capacity (sample + heating element) (J K⁻¹)
- *d* sample and heat element half-length (m)
- e thickness (m)
- *N* number of experimental points
- S sample and heating element area (m^2)
- T sample temperature (°C)
- T_i initial temperature of the system (°C)
- ΔT temperature difference between the heating element and the blocks (°C)

- ϕ_0 heat flux density in the heating element (W m⁻²)
- φ_0 heat flux in the heating element (W)
- Φ Laplace transform of the heat flux
- λ thermal conductivity (W m⁻¹ K⁻¹)
- ρ density (kg m⁻³)
- σ_X standard deviation on the parameter X
- θ Laplace transform of the temperature T

Subscripts

- *b* isothermal blocks
- c center
- exp experimental
- *h* heating element
- mod model

1. Introduction

The thermal conductivity of thin insulating and superinsulating materials (materials with thermal conductivity lower than air conductivity) is difficult to measure, particularly for very low density materials. Many different methods are available for thermal conductivity measurement of insulating materials; the more frequently used and the latest published are as follows.

- The guarded hot plate method [1–3]
- The hot wire method [4–7]
- The hot strip method [8, 9]
- The hot disk method [10–12], the tiny hot plate method [13] and the three-layer device method [14].

These methods present the following disadvantages.

- The guarded hot plate method needs large samples (50 \times 50 cm²).
- The hot wire method enables the estimation of the thermal conductivity from the slope of the curve $T(t) = f[\ln(t)]$ assuming two hypotheses: the sample is semi-infinite and the sensitivity of the temperature to the thermal capacity of the probe is negligible. This last hypothesis is verified only after a time that increases when the density of the material decreases. Even if the use of a complete model (taking into account the thermal capacity of the probe) enables us to process the temperature recording from the beginning, the validity of the first hypothesis (semi-infinite medium) may impose large sample dimensions. The conductivity estimation may be wrong if the sample is not large and thick enough or if the estimation time is too short [7].
- The hot strip and hot disk methods are based on a model, and an estimation method quite complex and the uncertainties in the probe dimensions may lead to an uncertainty in the thermal conductivity estimation.
- The tiny hot plate and three-layer device methods are based on the processing of mean temperatures that impose taking into account the convective heat transfer on the lateral faces of the sample. Moreover, in the case of super-insulating materials, the conductive heat transfer in the air surrounding the sample is not negligible compared to the heat transfer inside the sample and must be taken into account. The heat transfer in the air is quite difficult to model since the boundary conditions in the air are not well known.
- The hot wire, hot strip and hot disk methods cannot lead to an estimation of the thermal conductivity in one direction from a unique experience for an anisotropic material.

The aim of this work was to propose a method.

- Easy to use and suited to relatively small samples, particularly to low thickness samples.
- Suited to low-conductivity measurement.
- Using an estimation method based on a simplified model whose validity may be verified *a posteriori* by a more complex model.

2. Materials and methods

The different elements that make up the experimental device represented in figure 1 are as follows.

- A heating element made of a plane resistance inserted between two insulating polymide films. Its thickness is $e_h = 0.22$ mm and a type K thermocouple (wire diameter of 0.03 mm) is fixed at the center. The heating element is inserted between two samples with a thickness *e*. The heating element and the samples have the same crosssection area *S*.
- Two isothermal aluminum blocks with a thickness 40 mm and the same cross-section *S* as the samples.
- A tightening device enabling pressure control and the measurement of the thickness of the device inserted between the aluminum blocks.

A flux step is sent in the heating element and the temperatures $T_{c_{exp}}(t)$ at the center of the heating element and $T_{b_{exp}}(t)$ of the aluminum blocks are recorded. The processing of the recording of $T_{c_{exp}}(t)$ and $T_{b_{exp}}(t)$ is realized by supposing that the heat transfer at the center of the heating element is 1D. A 3D model will enable us to verify this hypothesis. A simplified 1D model is then used to estimate the thermal characteristics: a stationary model is sufficient to estimate the thermal conductivity λ , and a transient model is used to estimate the thermal capacity ρc .

The following hypotheses have been considered.

- The system is at a uniform temperature *T_i* (equal to the ambient air temperature) at initial time.
- The sample is opaque.
- Thermal contact resistances and thermal resistance of the heating element are negligible compared to the sample thermal resistance.

3D model

The system will be first modeled with the hypothesis that the thermal capacity of the aluminum blocks is large enough so that the temperature $T_{b_{exp}}$ remains constant during the experiment (cf figure 2). If T(x, y, z, t) is the temperature of the sample, the heat transfer equation is

$$\frac{\partial^2 T(x, y, z, t)}{\partial x^2} + \frac{\partial^2 T(x, y, z, t)}{\partial y^2} + \frac{\partial^2 T(x, y, t)}{\partial z^2}$$
$$= \frac{1}{a} \frac{\partial T(x, y, z, t)}{\partial t}$$
(1)

where *a* is the thermal diffusivity $(m^2 s^{-1})$ of the sample. The initial condition is

$$T(x, y, z, 0) = T_i.$$
 (2)

The boundary conditions are

$$\frac{\partial T(0, y, z, t)}{\partial x} = 0 \tag{3}$$

$$\frac{\partial T(x,0,z,t)}{\partial y} = 0 \tag{4}$$

$$-\lambda \frac{\partial T(b, y, z, t)}{\partial x} = h[T(b, y, z, t) - T_i]$$
(5)



Figure 1. Schema of the experimental device.

fine h $T(x,y,e,t) = T_i$

Figure 2. Schema of the modeled system.

$$-\lambda \frac{\partial T(x, d, z, t)}{\partial y} = h[T(x, d, z, t) - T_i]$$
(6)

$$T(x, y, e, t) = T_i.$$
(7)

Since the thermal contact resistances and thermal resistance of the heating element are supposed negligible, the temperature of the heating element $T_h(x, y, t)$ is equal to T(x, y, 0, t) and

$$\frac{\phi_0}{2} = \frac{1}{2}\rho_h e_h c_h \frac{\partial T(x, y, 0, t)}{\partial t} - \lambda \frac{\partial T(x, y, 0, t)}{\partial z}$$
(8)

where λ is the sample thermal conductivity (W m⁻¹ K⁻¹); *e*, 2*b* and 2*d* are respectively the thickness, the width and the length (m) of the samples; ρ_h , c_h and e_h are respectively the density (kg m⁻³), the specific heat (J kg⁻¹ K⁻¹) and the thickness (m) of the heating element; *h* is the convective heat transfer coefficient (W m⁻² K⁻¹) and ϕ_0 is the heat flux density produced in the heating element (W m⁻²).

Setting

$$\Delta T(x, y, z, t) = T(x, y, z, t) - T_i \quad \text{and} \mathcal{L}[\Delta T(x, y, z, t)] = \theta(x, y, z, p),$$
(9)

where \mathcal{L} is the Laplace operator, the Laplace transform of relation (1) leads to

$$\frac{\partial^2 \theta(x, y, z, p)}{\partial x^2} + \frac{\partial^2 \theta(x, y, z, p)}{\partial y^2} + \frac{\partial^2 \theta(x, y, z, p)}{\partial z^2}$$
$$= \frac{p}{a} \theta(x, y, p).$$
(10)

Using the separation of variables method, the Laplace transform of the temperature may be written as

$$\theta(x, y, z, p) = X(x, p)Y(y, p)Z(z, p).$$
(11)

The resolution of the system of equations (1) to (11) leads to

$$\theta(x, y, z, p) = \sum_{p=1}^{\infty} \sum_{q=1}^{\infty} \frac{\Phi_0(p)}{2} \frac{\sin(\alpha_p b)}{\alpha_p} \frac{\sin(\delta_q d)}{\delta_q} \cos(\alpha_p x) \cos(\delta_q y) \sinh[\gamma_{pq}(e-z)]}{G_{pq} \left[\frac{\sin(2\alpha_p b)}{4\alpha_p} + \frac{b}{2}\right] \left[\frac{\sin(2\delta_q d)}{4\delta_q} + \frac{d}{2}\right]}$$
(12)

where

$$G_{pq} = \lambda \gamma_{pq} \sinh(\gamma_{pq} e) + \frac{\rho_h c_h e_h}{2} p \cosh(\gamma_{pq} e).$$
(13)

 α_n are the solutions of the equation $\alpha b \tan(\alpha b) = H_x$, with

$$H_x = \frac{hb}{\lambda}.$$
 (14)

 δ_n are the solutions of the equation $\delta d \tan(\delta d) = H_y$, with

$$H_{y} = \frac{hd}{\lambda}.$$
 (15)

The values of γ are then given by

$$\gamma_{pq}^2 = \frac{p}{a} + \alpha_p^2 + \delta_q^2. \tag{16}$$

 $\Phi_0(p)$ is the Laplace transform of the heat flux in the heating element; in the case of a flux step its expression is

$$\Phi_0(p) = \frac{\phi_0}{p}.\tag{17}$$

One can deduce the expression of the Laplace transform of the temperature at the center of the heated face of the sample:

$$\theta(0,0,0,p) = \sum_{p=1}^{\infty} \sum_{q=1}^{\infty} \frac{\frac{\Phi_0(p)}{2} \frac{\sin(\alpha_p b)}{\alpha_p} \frac{\sin(\delta_q d)}{\delta_q} \cosh(\gamma_{pq} e)}{G_{pq} \left[\frac{\sin(2\alpha_p b)}{4\alpha_p} + \frac{b}{2}\right] \left[\frac{\sin(2\delta_q d)}{4\delta_q} + \frac{d}{2}\right]}.$$
(18)

1D model

A simplified model may be established by considering the supplementary hypothesis that the heat transfer remains 1D at the center of the system during the experiment. With this hypothesis, the center temperature depends only on *z* and *t* and will be denoted by $T_c(z, t)$ and its Laplace transform will be denoted by $\theta_c(z, p)$.

The temperature in the aluminum blocks is no longer supposed time independent but is supposed uniform. This last hypothesis is validated if the Biot number $Bi = \frac{hb}{\lambda}$ is lower than 0.1. Considering h = 10 W m⁻² K⁻¹, thermal

conductivity of the block $\lambda_b = 200 \text{ W m}^{-1} \text{ K}^{-1}$ and sample dimensions b = d = 100 mm lead to Bi = 0.005 so that the temperature of the aluminum blocks may be considered as uniform.

Since the thermal contact resistance has been neglected, the temperature of the isothermal blocks $T_b(t)$ is equal to $T_c(e, t)$.

Thus, the quadrupolar equation may be written [15] as

$$\begin{bmatrix} \theta_c(0, p) \\ \Phi_c(0, p) \end{bmatrix} = \begin{bmatrix} 1 & 0 \\ C_h p & 1 \end{bmatrix} \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} \theta_c(e, p) \\ \Phi_c(e, p) \end{bmatrix}$$
(19)

where $A = D = \cosh\left(\sqrt{\frac{p}{a}}e\right);$ $B = \frac{\sinh\left(\sqrt{\frac{p}{a}}e\right)}{\lambda S\sqrt{\frac{p}{a}}};$ C =

 $\lambda S \sqrt{\frac{p}{a}} \sinh \left(\sqrt{\frac{p}{a}} e \right)$; *S* is the surface area of the sample and of the heating element; $C_h = \frac{1}{2} \rho_h c_h e_h S$ where ρ_h , c_h and e_h are respectively the density (kg m⁻³), the specific heat (J kg⁻¹ K⁻¹) and the thickness (m) of the heating element.

Furthermore, the heat flux at the center of the unheated face of the sample may be calculated as

$$\varphi_c(e,t) = C_b \frac{\mathrm{d}T_c(e,t)}{\mathrm{d}t} + hS_bT_c(e,t)$$
(20)

where $C_b = \rho_b c_b e_b S$ with ρ_b , c_b and e_b respectively the density (kg m⁻³), the specific heat (J kg⁻¹ K⁻¹) and the thickness (m) of the isothermal blocks and S_b the total exchange surface area between the ambient air and the isothermal block.

Its Laplace transform is

$$\Phi_c(e, p) = (C_b p + hS_b)\theta_c(e, p).$$
(21)

It may be deduced that

$$\begin{bmatrix} \theta_c(0, p) \\ \Phi_c(0, p) \end{bmatrix} = \begin{bmatrix} A & B \\ AC_h p + C & BC_h p + D \end{bmatrix} \begin{bmatrix} \theta_c(e, p) \\ (C_b p + hS_b)\theta_c(e, p) \end{bmatrix}$$
(22)

leading to

$$\theta_c(0, p) = \frac{A + B(C_b p + hS_b)}{AC_h p + C + (BC_h p + D)(C_b p + hS_b)} \Phi_c(0, p)$$
(23)

and

$$\theta_c(e, p) = \frac{1}{AC_h p + C + (BC_h p + D)(C_b p + hS_b)} \Phi_c(0, p).$$
(24)

Simplified 1D model

A simpler 1D model may also be written with the hypothesis that the temperature of the isothermal blocks remains constant, within this hypothesis one can write

$$\begin{bmatrix} \theta_c(0, p) \\ \Phi_c(0, p) \end{bmatrix} = \begin{bmatrix} 1 & 0 \\ C_h p & 1 \end{bmatrix} \begin{bmatrix} A & B \\ C & D \end{bmatrix} \begin{bmatrix} 0 \\ \Phi_c(e, p) \end{bmatrix}.$$
 (25)

This equation leads to

$$\theta_c(0, p) = \Phi_c(0, p) \frac{B}{BC_h p + D}.$$
(26)

Table 1. Characteristics of the materials considered in the sensitivity analysis.

	$\lambda \ (W \ m^{-1} \ K^{-1})$	$a (\mathrm{m}^2 \mathrm{s}^{-1})$	$\rho c (J m^{-3} K^{-1})$		
PVC Low-density insulator	0.184 0.040	$\begin{array}{l} 1.21 \times 10^{-7} \\ 5.00 \times 10^{-7} \end{array}$			
Super-insulator	0.015	1.30×10^{-7}	1.15×10^5		

For 'long times'

$$T_c(0, t \to \infty) = \frac{\phi_0}{\frac{\lambda}{c}}.$$
 (27)

Actually, the temperature $T_c(e, t)$ increases after a certain time (corresponding to $p \rightarrow 0$). Figure 3 represents $T_c(0, t)$, $T_c(e, t)$ and $\Delta T_c(t) = T_c(0, t) - T_c(e, t)$ calculated with relations (23) and (24) and $T_c(0, t)$ calculated with relation (26). Calculations have been realized for two different insulating materials whose properties are given in table 1, considering aluminum blocks with a thickness $e_b = 40$ mm and a convection heat transfer coefficient h = 10 W m⁻² K⁻². Figure 3 shows that the difference between the temperature $T_c(0, t)$ calculated with relation (26) and the temperature difference $\Delta T_c(t)$ is negligible.

The principle of the method is thus to estimate the values of the parameters λ and eventually ρc and $\rho_h c_h$ which minimize the sum of the quadratic errors $\Psi = \sum_{i=1}^{N} [\Delta T_{cexp}(t_i) - T_{cmod}(t_i)]^2$ between the experimental curve $\Delta T_{cexp}(t) = T_{c(0, t)} - T_{cexp}(e, t)$ and the theoretical curve $T_{cmod}(t) = T_c(0, t)$ calculated with relation (26) supposing that the heat transfer remains 1D at the center of the heating element. The validity of this hypothesis may be examined *a posteriori* using the 3D model.

For the 3D model, a number of 50 terms is enough to reach the convergence for the calculation of the Laplace transform of the temperature at the center of the heating element with relation (12). The roots of equations (14) and (15) are calculated numerically. The inverse Laplace transform is realized by use of the De Hoog algorithm [16].

The minimization of the sum ψ is realized by use of the Levenberg–Marquardt algorithm.

Discussion of hypotheses

The thermal contact resistance between the sample and the heating element and between the sample and the isothermal block may be considered lower than 2×10^{-4} K W⁻¹ m⁻² [13].

The thermal resistance of the sample is $\frac{e}{\lambda}$. Thus, the thermal contact resistances may be neglected (less than 1% error) compared to the sample thermal resistance if

$$\frac{e}{\lambda} > 0.02 \text{ K W}^{-1} \text{m}^{-2}.$$
 (28)

The 3D model has then been used to estimate the limits of validity of the 1D model considering an upper value $h = 10 \text{ W m}^{-2} \text{ K}^{-1}$ for the convective lateral heat transfer coefficient. For a given section area of the heating element, we have calculated the sample thickness that leads to an error of



Super-insulating material, $\lambda = 0.015 \text{ W.m}^{-1}$.K⁻¹, $\rho c = 1.15 \times 10^5 \text{ J.m}^{-3}$, e = 6 mm

Figure 3. Simulations of $T_c(0, t)$ for a super-insulating material and for PVC.



Figure 4. Limits of the sample thickness value to satisfy the hypotheses of the simplified 1D model (square heating element with side half-length *b*).

1% when estimating the thermal conductivity λ with relation (27). The section of the heating element was supposed to be a square with a side half-length *b*.

In figure 4 the following are represented (as a function of the thermal conductivity of the sample).

• The minimum sample thickness required for satisfying the hypothesis that the thermal contact resistance and

the heating element thermal resistance are negligible compared to the sample thermal resistance.

• The maximum sample thickness required for satisfying the hypothesis that the heat transfer remains 1D at the center of the heating element. Calculations have been realized for three different values of *b*.

Figure 4 enables us to define easily whether a couple of values (e, λ) satisfy the hypothesis of the simplified 1D model.

3. Sensitivity analysis

The sensitivity analysis is based on the interpretation of the reduced sensitivity of T(t) to X: $X \frac{\partial T}{\partial X}(t)$ providing information on the influence of the parameter X on the temperature T according to Beck [17].

The sensitivity analysis has been realized for three opaque insulating materials with a thickness e = 6 mm whose properties are reported in table 1. We considered a heating element with a thickness $e_h = 0.25$ mm and a thermal capacity $\rho_h c_h = 1.5 \times 10^6$ J m⁻³ K⁻¹. With the hypothesis that the heat transfer is 1D at the center of the heating element, the reduced sensitivities of the center temperature $T_c(0, t)$ to the different parameters have been calculated. All the results are presented in figure 5.

One can see that





Low density insulator, $\lambda = 0.04 \text{ W.m}^{-1} \text{.K}^{-1}$, $\rho c = 8.0 \times 10^4 \text{ J.m}^{-3}$, e = 6 mm



Figure 5. Reduced sensitivities of $T_c(0, t)$ for three insulating materials.

- the sensitivity to the thermal conductivity is high and uncorrelated to the other sensitivities,
- the sensitivity to ρc is rather proportional to the value of ρc and
- the sensitivities to $\rho_h c_h$ and to ρc are uncorrelated only for short times and will be difficult to estimate separately especially for low-density materials for which the sensitivity to $\rho_h c_h$ is superior to the sensitivity to ρc .

To decorrelate the sensitivities to $\rho_h c_h$ and ρc , we imagine an experiment with two samples of the same material having two different thicknesses. In this case, relation (26) is modified as follows:

$$\theta_c(0, p) = \frac{\Phi_c(0, p)}{\frac{B_1}{2B_1C_1(p+D_1)} + \frac{B_2}{D_2}}$$
(29)

where $B_1 = \frac{\sinh\left(\sqrt{\frac{p}{a}}e\right)}{\lambda\sqrt{\frac{p}{a}}}; \quad D_1 = \cosh\left(\sqrt{\frac{p}{a}}e\right); \quad B_2 = \frac{\sinh\left(\sqrt{\frac{p}{a}}2e\right)}{\lambda\sqrt{\frac{p}{a}}}; \quad D_2 = \cosh\left(\sqrt{\frac{p}{a}}2e\right).$

As an example, figure 6 represents the ratio of the reduced sensitivities to ρc and $\rho_h c_h$ calculated with relations (27) and (29) for the low-density insulating material whose properties are given in table 1.

- (a) With two samples of the same thickness e = 3 mm.
- (b) With two samples of the same thickness e = 6 mm.
- (c) With one sample of thickness $e_1 = 3$ mm and the other sample of thickness $e_2 = 6$ mm.

It can be seen in figure 6 that the device with two samples of different thicknesses leads to a better decorrelation of the parameters $\rho_h c_h$ and ρc than the device with two samples having the same thickness. This asymmetric device must be preferred when it is possible after having verified that the temperature $T_c(e, t)$ remains constant during the experiment since it has been shown that the sensitivities to the parameters $\rho_h c_h$ and ρc are correlated in a symmetrical device and that their separate estimation is not precise.

The use of the 3D model enables the verification of the similarity between the temperatures at the center of the heating element calculated with the 1D and the 3D models for the materials and the experiment duration considered in this analysis.

This sensitivity analysis predicts that the thermal conductivity λ may be estimated precisely with this method but that it will be difficult to estimate separately the thermal capacities ρc of the sample and $\rho_h c_h$ of the heating element especially for low-density materials. These conclusions will be confirmed by the experimental study.

4. Experimental results and discussion

Measurements have been realized using a heating element MINCO HK 5489 made of a plane resistance inserted between two insulating polymide films, with a heated surface $100 \pm 1 \text{ mm} \times 100 \pm 1 \text{ mm}$ and a thickness $0.22 \pm 0.01 \text{ mm}$.

The uncertainty in the heating element area is thus around 2%. One must add the uncertainty in the sample thickness estimated to 1% and in the heat flux produced in the heating element, estimated to 0.5%. The sum of these uncertainties leads to a global uncertainty of 3.5% to which must be added the estimation error due to the noise measurement on ΔT and the errors due to the phenomena that have not been taken into account in the model.

Measurements have been realized on four different sample couples:

- E1: polyethylene foam ($\rho = 40 \text{ kg m}^{-3}$), two samples with a thickness 3 mm
- E2: polyethylene foam, a sample with a thickness 3 mm and a sample with a thickness 6 mm
- E3: polyethylene foam, two samples with a thickness 6 mm
- E4: PVC, two samples with a thickness 5.89 mm

The thermal conductivity and the thermal capacity of the polyethylene foam measured with the three-layer method are respectively $\lambda = 0.042$ W m⁻¹ K⁻¹ and $\rho c = 9.50 \times 10^4$ J m⁻³ K⁻¹. The thermal diffusivity of the PVC measured by the flash method is $a = 1.21 \times 10^{-7}$ m² s⁻¹ and its thermal



Figure 6. Ratio of the reduced sensitivities of $T_c(0, t)$ to ρc and to $\rho_h c_h$ calculated for different sample thicknesses of a low-density insulator.

Table 2. Estimation results.

Test Nr		Relation (26) or (29)				Relation (27)
	Sample	$\overline{\lambda \; (W \; m^{-1} \; K^{-1})}$	$\rho c (J \text{ m}^{-3} \text{ K}^{-1})$	$\rho_h c_h (\mathrm{J} \mathrm{m}^{-3} \mathrm{K}^{-1})$	$Ct (J K^{-1})$	$\lambda \ (W \ m^{-1} \ K^{-1})$
1	E1: polyethylene foam $(e_1 = e_2 = 3 \text{ mm})$	0.0411	0.603×10^{5}	1.295×10^{6}	3.87	0.0411
2	. 2 ,	0.0406	0.829×10^{5}	1.183×10^{6}	4.43	0.0406
3		0.0406	1.152×10^{5}	0.980×10^{6}	5.16	0.0406
Mean		0.0408	0.861×10^{5}	1.153×10^{6}	4.49	0.0408
Standard deviation		0.71%	32.0%	13.9%	14.3%	0.71%
4	E2: polyethylene foam $(e_1 = 3 \text{ mm}; e_2 = 6 \text{ mm})$	0.0412	0.843×10^{5}	1.161×10^{6}	5.79	0.0412
5		0.0408	0.856×10^{5}	1.166×10^{6}	5.86	0.0408
6		0.0416	0.777×10^{5}	1.278×10^{6}	5.65	0.0416
Mean		0.0412	0.825×10^{5}	1.202×10^{6}	5.76	0.0412
Standard deviation		0.97%	5.1%	5.5%	0.93%	0.97%
7	E3: polyethylene foam ($e_1 = e_2 = 6 \text{ mm}$)	0.0402	0.871×10^{5}	1.201×10^{6}	7.38	0.0403
8	, <u> </u>	0.0401	0.868×10^{5}	1.187×10^{6}	7.34	0.0404
9		0.0399	0.761×10^{5}	1.292×10^{6}	6.81	0.0401
Mean		0.0401	0.833×10^{5}	1.227×10^{6}	7.14	0.0403
Standard deviation		0.39%	7.6%	4.6%	4.5%	0.41%
10	E4: PVC $(e_1 = e_2 = 5.89 \text{ mm})$	0.176	1.515×10^{6}	0 ^a	90.8	0.176
11		0.178	1.536×10^{6}		92.2	0.178
12		0.174	1.577×10^{6}		94.6	0.174
Mean		0.176	1.543×10^{6}		92.6	0.176
Standard deviation		1.14%	2.03%		2.03%	1.14%

^a In case of PVC, a too low sensitivity to $\rho_h c_h$ prevents the estimation of $\rho_h c_h$ (fixed to null value).

conductivity measured by the tiny hot plate method is $\lambda = 0.184$ W m⁻¹ K⁻¹, and its thermal capacity is thus $\rho c = 1.52 \times 10^6$ J m⁻³ K⁻¹.

Three measures have been realized for each sample couples. The parameter values λ , ρc and $\rho_h c_h$ have been estimated by minimization of the sum of the quadratic errors between the experimental curve $\Delta T_{c_{exp}}(t) = T_{c_{exp}}(0, t) - T_{c_{exp}}(e, t)$ and the theoretical curve $T_c(0, t)$ calculated with relation (26). Figure 7 represents an example of an experimental curve and of the curve simulated with the estimated parameters; the residues defined as the difference between the experimental points and the model are also represented in the same figure. Table 2 presents a review of the experimental results.

- The estimated values of the thermal conductivity λ of the two materials are in good agreement with those measured with other methods (deviation less than 5%).
- In all cases, the value of the thermal conductivity λ calculated with relation (26) in the semi-permanent



Figure 7. Example of experimental and simulated curves $T_c(0, t)$ and estimation residues $\times 10$ (—).

regime is the same as the value estimated (both with the value of $\rho_h c_h$ and ρc) from the transient regime.

• The reproducibility of the method is very good for the estimation of λ with a standard deviation around 1% between the results of the three measurements.

- The thermal capacity ρc of the PVC measured by this method is very close (deviation < 1%) to the value estimated by the hot plate and the tiny hot plate methods. The deviation of ρc for the polyethylene foam is greater (around 13%).
- The estimations of ρc are more dispersed particularly for the lower density samples and strongly correlated to the values of $\rho_h c_h$. This is illustrated by the values of ρc , $\rho_h c_h$ and of the global thermal capacity $C_t =$ $S(e_h \rho_h c_h + e \rho c)$ of the ensemble heating element + sample presented in table 1. The dispersion of the values of the global thermal capacity C_t is lower than the dispersion of the values of ρc and $\rho_h c_h$. The value of $\rho_h c_h$ could be previously determined by a measurement realized with a low-density material with a well-known thermal capacity ρc . This value of $\rho_h c_h$ may then be considered as data leading to an estimation of only λ and ρc to reduce the dispersion on the estimated values of ρc .
- When comparing in table 1, the results obtained with the polyethylene foam for the measurements realized with the samples E2 (two samples of different thickness: $e_1 = 3 \text{ mm}$ and $e_2 = 6 \text{ mm}$) and E1 (two samples of the same thickness: e = 3 mm), it can be noticed that the device with two different thickness (E2) leads to lower standard deviation on the estimated values of ρc and $\rho_h c_h$ than the symmetrical device: 32.0% and 13.9% for E1 compared with 5.1% and 5.5% for E2. This result is in agreement with the sensitivity analysis.
- The standard deviations obtained with the asymmetrical device E2 are close to those obtained with the symmetrical device E3 (two samples of the same thickness: e = 6 mm) for the values of $\rho_h c_h$: 5.5% and 4.6%, and lower for the values of ρc : 5.1% and 7.6%. The standard deviation of the estimated values of the global thermal capacity *Ct* (including the heating element and the sample thermal capacity) is clearly lower in the asymmetrical device E2 than in the symmetrical device E3: 0.93% and 4.5%. The conclusion is that if $\rho_h c_h$ is known, the value of ρc may be determined more precisely with the asymmetrical device.

5. Conclusion

The centered hot plate method described in this paper enables the estimation of the thermal conductivity of thin insulating and super-insulating materials with quite a simple device. The thermal conductivity may be estimated with good precision using a simple relation established for a steady state measurement: the deviation of the estimated values from the values measured with other classical devices is less than 5%. The measurement of a local temperature at the center of the heating element avoids us using a hot guard or taking into account the lateral convective losses.

The validity of the hypotheses enabling the use of this simple relation may be verified *a posteriori* with the 3D model that we have developed.

The processing of the temperature transient recording also enables the estimation of the thermal capacity ρc of the tested material. The precision of this estimation will be better if the total thermal capacity ρce of the sample is high. In all cases, this estimation will be better if an insulating material with known thermal properties is used to estimate the effective heating area *S* of the heating element and its thermal capacity $\rho_h c_h$.

It has also been shown that an asymmetrical device with two samples of different thickness leads to a better estimation of the thermal capacity ρc of the sample especially if the thermal capacity $\rho_h c_h$ of the heating element is known.

References

- Salmon D 2001 Thermal conductivity of insulations using guarded hot plates, including recent developments and source of reference materials *Meas. Sci. Technol.* 12 89–98
- [2] Xamán J, Lira L and Arce J 2009 Analysis of the temperature distribution in a guarded hot plate apparatus for measuring thermal conductivity *Appl. Therm. Eng.* 29 617–23
- [3] Huang J 2006 Sweating guarded hot plate test method *Polym. Test.* 25 709–16
- [4] Andersson P 1976 Thermal conductivity of some rubbers under pressure by the transient hot-wire method *J. Appl. Phys.* 47 2424–6
- [5] Zhang X, Degiovanni A and Maillet D 1993 Hot-wire measurement of thermal conductivity of solids: a new approach *High Temp. High Press.* 25 577–84
- [6] Rharbaoui B 1994 Contribution à l'étude de la mesure simultanée de la conductivité et de la diffusivité thermiques par la méthode du fil chaud *Thèse de doctorat* Université d'Angers
- [7] Coquard R, Baillis D and Quenard D 2006 Experimental and theoretical study of the hot-wire method applied to low-density thermal insulators *Int. J. Heat Mass Transfer* 49 4511–24
- [8] Ladevie B, Fudym O and Batsale J C 2000 A new simple device to estimate thermophysical properties of insulating materials *Int. Commun. Heat Mass Transfer* 17 473–84
- [9] Gobbé C, Iserna S and Ladevie B 2004 Hot strip method: application to thermal characterization of orthotropic media *Int. J. Therm. Sci.* 23 951–8
- [10] Gustafsson S E 1991 Transient plane source techniques for thermal conductivity and thermal diffusivity measurements of solid materials *Rev. Sci. Instrum.* 62 797–804
- [11] Gustavsson M, Karawacki E and Gustafsson S E 1994 Thermal conductivity, thermal diffusivity and specific heat of thin samples from transient measurement with hot disk sensors *Rev. Sci. Instrum.* 65 3856–9
- [12] He Y 2005 Rapid thermal conductivity measurement with a hot disk sensor: Part 1. Theoretical considerations *Thermochimica Acta* 436 122–9
- [13] Jannot Y, Remy B and Degiovanni A 2009 Measurement of thermal conductivity and thermal resistance with a tiny hot plate *High Temp. High Press.* 38 (4) at press
- [14] Jannot Y, Degiovanni A and Payet G 2009 Thermal conductivity measurement of insulating materials with a three layers device *Int. J. Heat Mass Transfer* 52 1105–11
- [15] Maillet D, André S, Batsale J C, Degiovanni A and Moyne C 2000 Thermal Quadrupoles (New York: Wiley)
- [16] De Hoog F R 1982 An improved method for numerical inversion of Laplace transforms Soc. Ind. Appl. Math. 3 357–66
- [17] Beck J V and Arnold K J 1977 Parameter Estimation in Engineering and Science (New York: Wiley)